

## **POWER RELAY**

# 1 POLE—15 to 25 A (FOR AUTOMOTIVE APPLICATIONS)

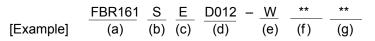
# **FBR161,166 Series**

RoHS compliant

### **■ FEATURES**

- Suitable for automotive applications such as motor load controls, door locks, power windows, wipers, etc.
- Variety of contact materials covering wide current switching in range of 15 A to 25 A (at 14 VDC)
- FBR166 series with high conductive spring and improved break performance is also available
- RoHS compliant since date code: 0626
   Please see page 9 for more information
- FBR161 Series

### ORDERING INFORMATION





(a)	Series Name	FBR161: 1 form C FBR161 Series			
(b)	Enclosure	S : Flux free type N : Plastic sealed type			
(c)	Coil Type	E : Nominal power 0.36 to 0.38 W C : Nominal power 0.45 to 0.5 W			
(d)	Nominal Voltage	D012 : 12 VDC (example)			
(e)	Contact Material	C : Silver copper (15 A maximum) W : Silver-tin oxide indium (20 A maximum) WB : Silver-tin oxide indium (25 A maximum)			
(f)	Custom Designation	Custom specification to be assigned			
(g)	Package Style	Nil : Standard tray -S : Tube carrier			

#### FBR166 Series

$$[\text{Example}] \qquad \frac{\text{FBR166}}{\text{(a)}} \quad \frac{\text{S}}{\text{(b)}} \quad \frac{\text{CD009}}{\text{(c)}} \quad - \quad \frac{\text{WB}}{\text{(d)}} \quad \frac{**}{\text{(e)}} - \frac{**}{\text{(f)}}$$

(a)	Series Name	FBR166: 1 form C FBR166 Series
(b)	Enclosure	S : Flux free type N : Plastic sealed type
(c)	Nominal Voltage	CD009 : 9 VDC (example)
(d)	Contact Material	WB : Silver-tin oxide indium (25 A maximum)
(e)	Custom Designation	Custom specification to be assigned
(f)	Package Style	Nil : Standard tray -S : Tube carrier

1

### ■ SPECIFICATIONS

ltem			Specifications				
Contact	Arrangement		1 Form C (SPDT)				
	Material		C : Silver copper (15 A maximum) W : Silver-tin oxide indium (20 A maximum) WB : Silver-tin oxide indium (25 A maximum)				
	Voltage Drop (resistance)		Maximum 100 mV (at 1 A 6 VDC)				
	Maximum C	arrying Current	Contact C and W type: 17 A/1 hour, 5 A (continuously) Contact WB type : 25 A/1 hour, 10 A (continuously) (25°C,100% rated coil voltage)				
	Maximum Switching Current		15 A 16 VDC (silver copper: C type) 20 A 16 VDC (silver-tin oxide indium : W type) 25 A 16 VDC (silver-tin oxide indium: WB type)				
Coil	Operating Temperature		-40°C to + 85°C (no frost) (refer to the CHARACTERISTIC DATA)				
	Storage Temperature		-40°C to + 100°C (no frost)				
Time Value	Operate (at nominal voltage)		Maximum 10 ms				
	Release (at nominal voltage)		Maximum 5 ms				
Life	Mechanical		$1 \times 10^7$ operations minimum				
	Electrical		FBR160 Series: $1 \times 10^5$ operations minimum FBR166 Series: $2 \times 10^5$ operations minimum (14 VDC, maximum switching current, resistive load) (refer to the CHARACTERISTIC DATA)				
Other	Vibration Resistance		10 to 55 Hz (double amplitude of 1.5 mm)				
	Shock	Misoperation	100 m/s <sup>2</sup> (11 ± <sup>1</sup> ms)				
	Resistance	Endurance	$1,000 \text{ m/s}^2 (11 \pm^1 \text{ ms})$				
	Weight		Approximately 11 g				

### **■ COIL RATINGS**

MODEL		Nominal voltage	Coil resistance voltage ±10%	Must operate voltage (+20°C)	Must operate voltage (+80°C)	Operating voltage (reference)	Nominal power	Contact material	Thermal resistance
FBR161 Series	FBR161S (N) ED009-W32	9 VDC*	210Ω	6.0 V	7.4 V	6.0 V to 14.0 V	Approx. 380 mW	Silver tin indium oxide	84°C/W
Series	FBR161S (N) ED009-W12	9 VDC*	225Ω	6.5 V	8.0 V	6.5 V to 14.0 V	Approx. 360 mW	Silver tin indium oxide	83°C/W
	FBR161S (N) ED009-WB38	9 VDC*	225Ω	6.3 V	8.0 V	6.5 V to 16.0 V	Approx. 360 mW	Silver tin indium oxide	
	FBR161S (N) CD012-C36	12 VDC	320Ω	7.3 V	9.0 V	7.3 V to 15.5 V	Approx. 450 mW	Silver copper	- 78°C/W
	FBR161S (N) CD012-W36	12 VDC	320Ω	7.3 V	9.0 V	7.3 V to 15.0 V	Approx. 450 mW	Silver tin indium oxide	
	FBR161S (N) CD012-W31	12 VDC	290Ω	7.3 V	9.0 V	7.3 V to 15.5 V	Approx. 500 mW	Silver tin indium oxide	76°C/W
FBR166 Series	FBR166S (N) CD009-WB	9 VDC*	120Ω	6.3 V	7.8 V	6.3 V to 14.0 V	Approx. 670 mW	Silver tin indium oxide	67°C/W
	FBR166S (N) CD012-WB	12 VDC	210Ω	7.3 V	9.0 V	7.3 V to 14.0 V	Approx. 680 mW	Silver tin indium oxide	

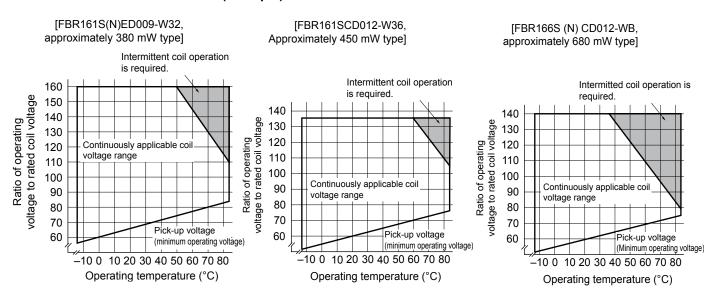
<sup>\*</sup> For typical 12 VDC automotive applications.

#### ■ CHARACTERISTIC DATA

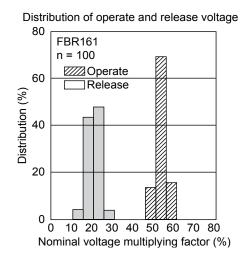
### 1. SERVICE LIFE WITH ACTUAL MOTOR LOAD TEST (example)

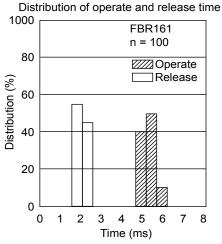
- Wiper motor (free, 16 VDC inrush 20 A, break 2 A) : more than  $3 \times 10^5$  operations (FBR160-W, silver tin oxide alloy)
- Wiper motor (free, 14 VDC inrush 25 A, break 5 A) : more than  $5 \times 10^5$  operations (FBR160-WB, silver tin oxide alloy)
- Door lock motor (stall, 14 VDC inrush -25 A) : more than  $1 \times 10^5$  operations (FBR160-W, silver tin oxide alloy)
- Door lock motor (stall, 14 VDC inrush -25 A) : more than  $2 \times 10^5$  operations (FBR166)

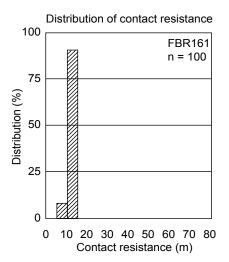
#### 2. OPERATING COIL VOLTAGE (example)



### **■ REFERENCE DATA**

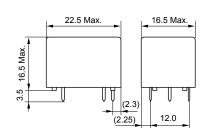






### **■** DIMENSIONS

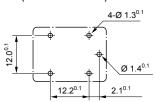
Dimensions



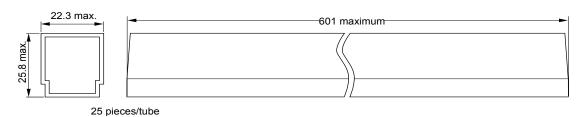
• Schematic (BOTTOM VIEW)



 PC board mounting hole layout (BOTTOM VIEW)



• Tube carrier



## **RoHS Compliance and Lead Free Relay Information**

### 1. General Information

- Relays produced after the specific date code that is indicated on each data sheet are lead-free now. Most of our signal and power relays are lead-free. Please refer to Lead-Free Status Info. (http://www.fujitsu.com/us/downloads/MICRO/fcai/relays/lead-free-letter.pdf)
- Lead free solder paste currently used in relays is Sn-3.0Ag-0.5Cu.
- All signal and most power relays also comply with RoHS. Please refer to individual data sheets. Relays that are RoHS compliant do not contain the 5 hazardous materials that are restricted by RoHS directive (lead, mercury, chromium IV, PBB, PBDE).
- It has been verified that using lead-free relays in leaded assembly process will not cause any problems (compatible).
- "LF" is marked on each outer and inner carton. (No marking on individual relays).
- To avoid leaded relays (for lead-free sample, etc.) please consult with area sales office.
- We will ship leaded relays as long as the leaded relay inventory exists.

Note: Cadmium was exempted from RoHS on October 21, 2005. (Amendment to Directive 2002/95/EC)

### 2. Recommended Lead Free Solder Profile

• Recommended solder paste Sn-3.0Ag-0.5Cu.

### **Reflow Solder condition**

### Flow Solder condition:

Pre-heating: maximum 120°C dip within 5 sec. at 260°C soler bath

### Solder by Soldering Iron:

Soldering Iron

Temperature: maximum 360°C Duration: maximum 3 sec.

We highly recommend that you confirm your actual solder conditions

## 3. Moisture Sensitivity

• Moisture Sensitivity Level standard is not applicable to electromechanical realys.

### 4. Tin Whisker

• Dipped SnAgCu solder is known as low risk tin whisker. No considerable length whisker was found by our in house test.

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